

Product Summary

V _{(BR)DSS}	R _{DS(on)TYP}	I _D
120V	3.2mΩ@10V	220A



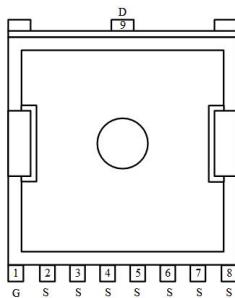
Feature

- Fast Switching
- Low Gate Charge and Rdson
- Low Reverse transfer capacitances
- 100% Single Pulse avalanche energy Test

Applications

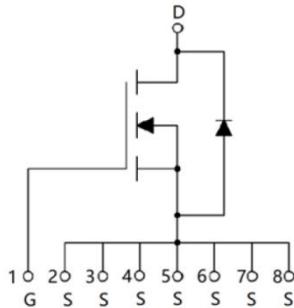
- High Speed Power switching
- DC-DC Converter
- Power Management

Package

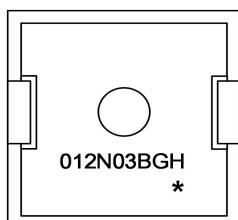


TOLL

Circuit diagram



Marking



012N03BGH : Product code
* : Month code

Order Information

Device	Package	Unit/Tape
SP012N03BGHTO	TOLL	2000

Absolute maximum ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V _{DS}	120	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current1 (Tc=25°C)	I _D	220	A
Continuous Drain Current1 (Tc=100°C)	I _D	147	A
Pulsed Drain Current	I _{DM}	880	A
Single Pulse Avalanche Energy ¹	E _{AS}	900	mJ
Power Dissipation (Tc=25°C)	P _D	296	W
Thermal Resistance Junction-to-Case	R _{θJC}	0.42	°C/W
Storage Temperature Range	T _{STG}	-55 to 150	°C
Operating Junction Temperature Range	T _J	-55 to 150	°C

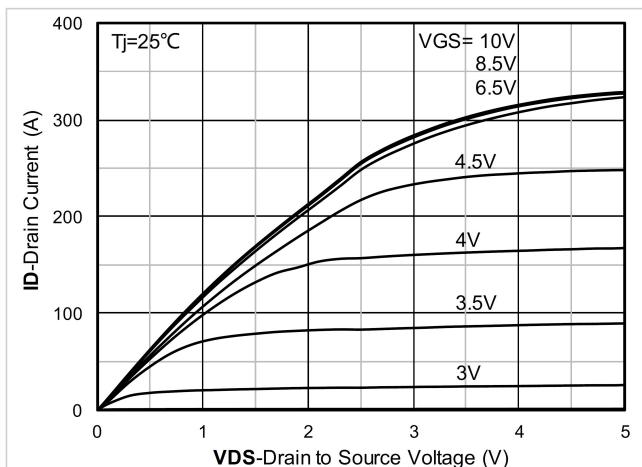
Electrical characteristics (Ta=25°C, unless otherwise noted)

Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	ID = 250μA, VGS = 0V	120	130	-	V
Drain Cut-Off Current	I _{DSS}	VDS = 96V, VGS = 0V	-	-	1	μA
Gate Leakage Current	I _{GSS}	VGS = ±20V, VDS = 0V	-	-	±0.1	
Gate Threshold Voltage	V _{GS(th)}	VDS = VGS, ID = 250μA	2.6	3.1	3.6	V
Drain-Source ON Resistance	R _{DS(ON)}	VGS = 10V, ID = 50A	-	3.2	4	mΩ
Dynamic Characteristics						
Input Capacitance	C _{iss}	VDS = 60V, VGS = 0V, f = 1.0MHz	-	5640	-	pF
Output Capacitance	C _{oss}		-	835	-	
Reverse Transfer Capacitance	C _{rss}		-	13	-	
Total Gate Charge	Q _g	VDS=60V , VGS=10V , ID=75A	-	152	-	nC
Gate-Source Charge	Q _{gs}		-	43	-	
Gate-Drain Charge	Q _{gd}		-	46	-	
Switching Characteristics						
Turn-On Delay Time	t _{d(on)}	VGS = 10V, VDS = 50V, ID = 75A RG = 1.6Ω	-	25	-	nS
Rise Time	t _r		-	15	-	
Turn-Off Delay Time	t _{d(off)}		-	52	-	
Fall Time	t _f		-	18	-	
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V _{SD}	I _S = 1A, V _{GS} = 0V	-	-	1.2	V
Maximum Body-Diode Continuous Current	I _S		-	-	220	A
Reverse Recovery Time	T _{rr}	I _S =100A, di/dt=100A/us, TJ=25°C	-	92	-	nS
Reverse Recovery Charge	Q _{rr}		-	183	-	nC

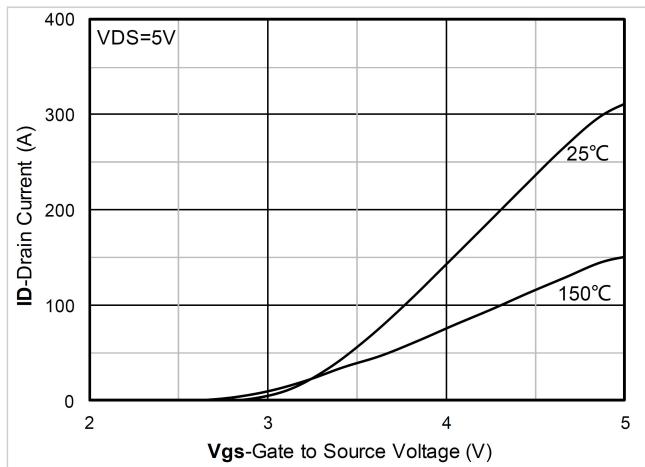
Note :

1. The test condition is VDD=50V,VGS=10V,L=0.5mH,RG=25Ω

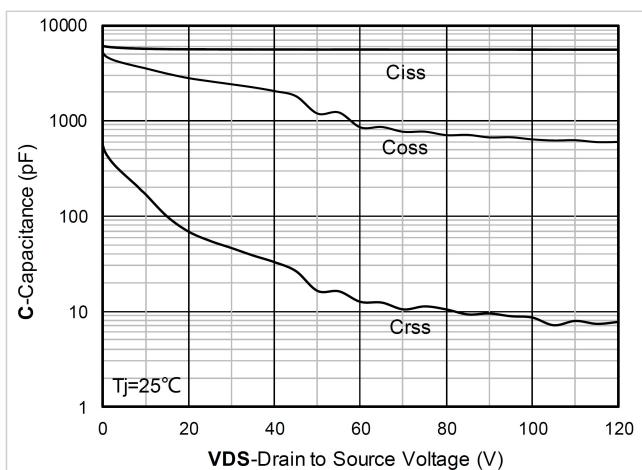
Typical Characteristics



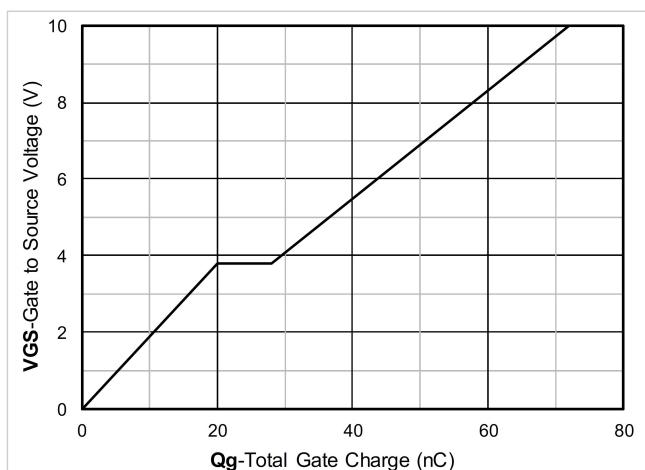
Output Characteristics



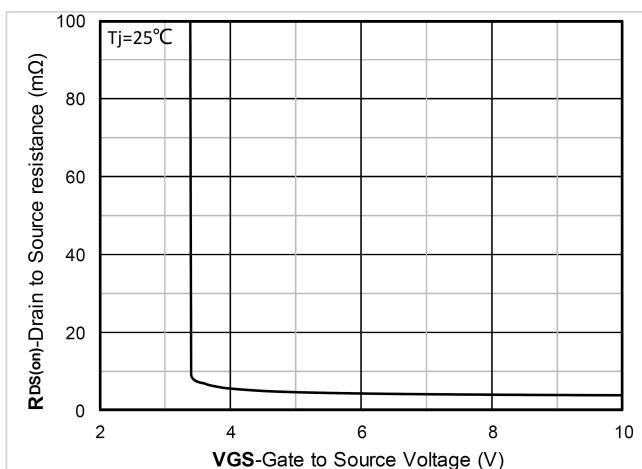
Transfer Characteristics



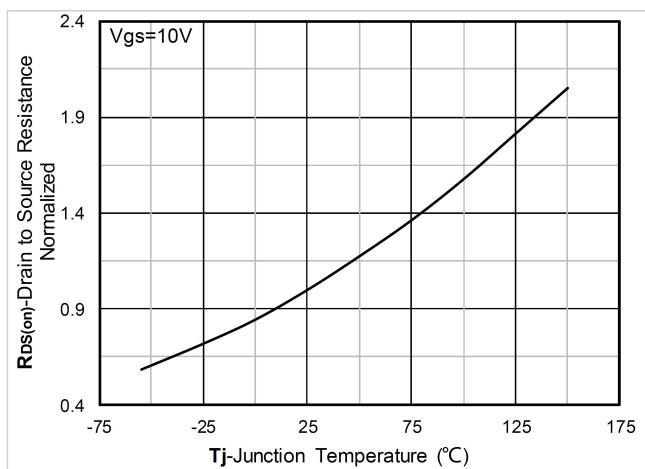
Capacitance Characteristics



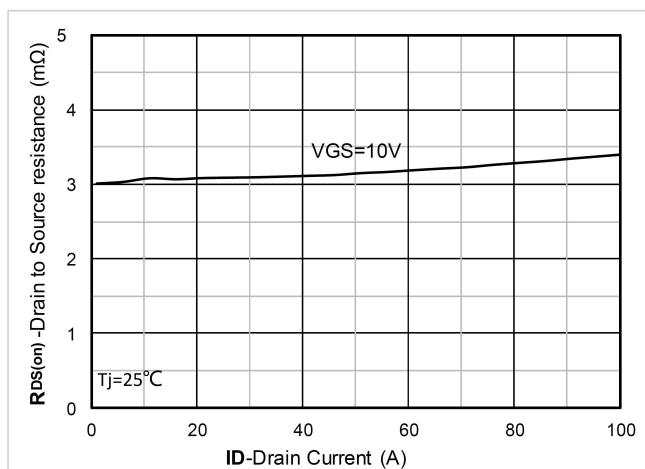
Gate Charge



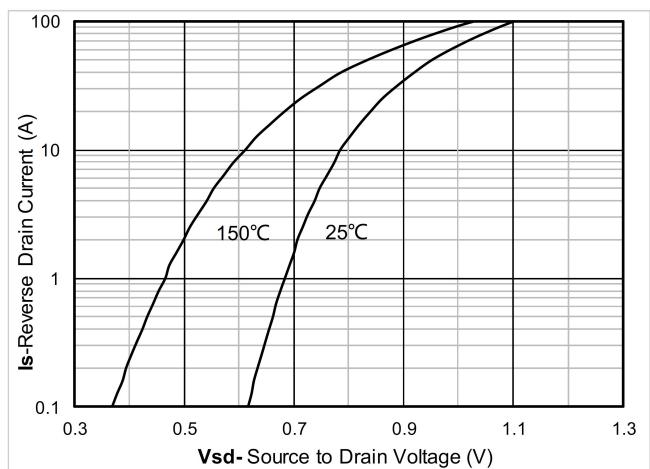
On-Resistance vs Gate to Source Voltage



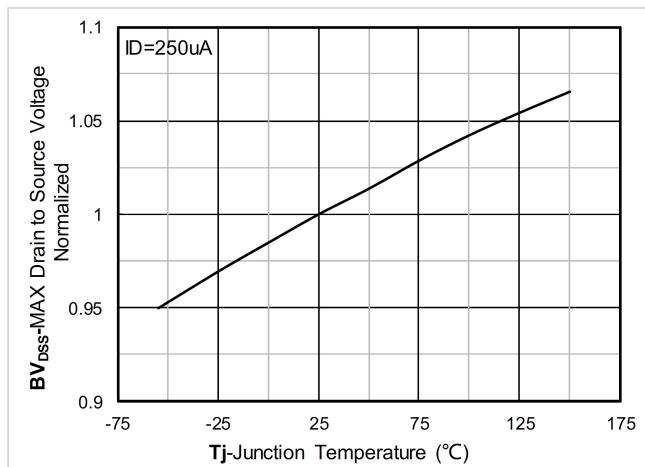
Normalized On-Resistance



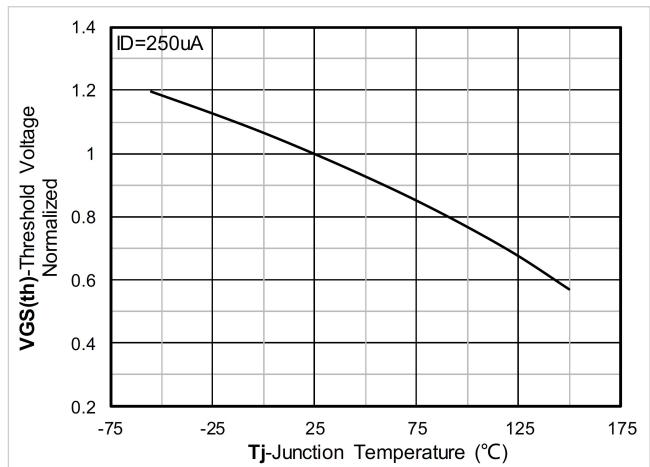
RDS(on) VS Drain Current



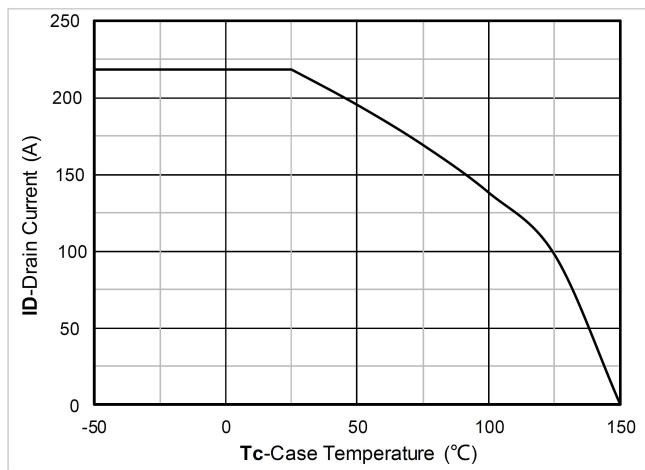
Forward characteristics of reverse diode



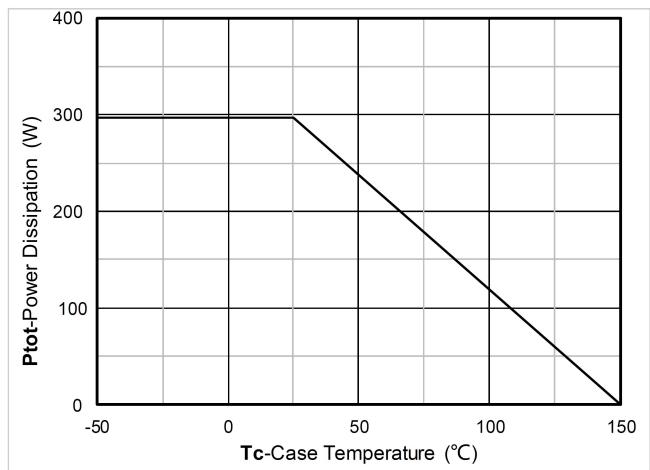
Normalized breakdown voltage



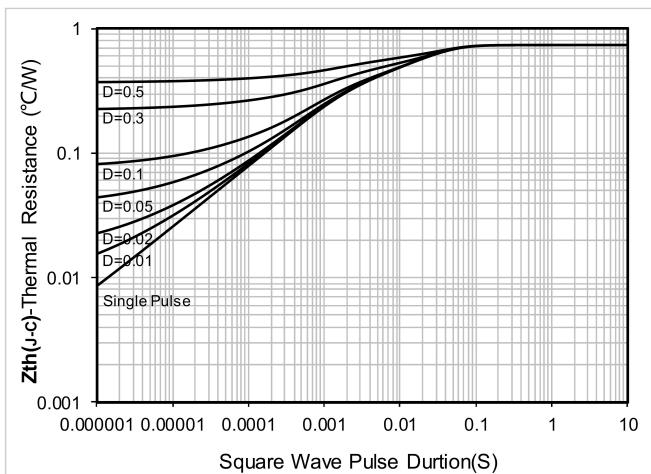
Normalized Threshold voltage



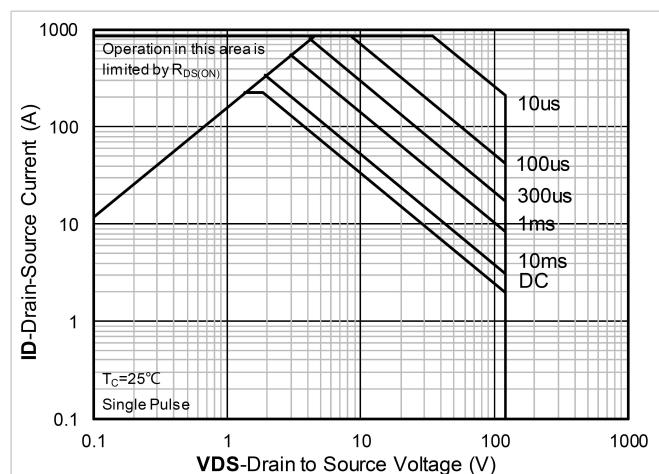
Current dissipation



Power dissipation

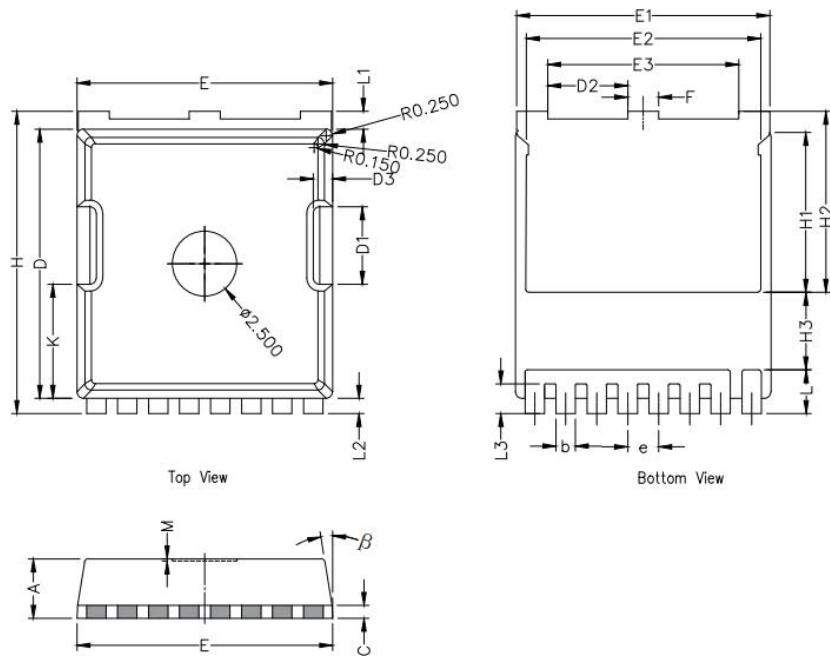


Maximum Transient Thermal Impedance



Safe Operation Area

TOLL Package Outline Dimensions



Symbol	Dimensions In Millimeters		
	Min.	Nom.	Max.
A	2.20	2.30	2.40
b	0.65	0.75	0.85
C	0.508 REF		
D	10.25	10.40	10.55
D ₁	2.85	3.00	3.15
E	9.75	9.90	10.05
E ₁	9.65	9.80	9.95
E ₂	8.95	9.10	9.25
E ₃	7.25	7.40	7.55
e	1.20 BSC		
F	1.05	1.20	1.35
H	11.55	11.70	11.85
H ₁	6.03	6.18	6.33
H ₂	6.85	7.00	7.15
H ₃	3.00 BSC		
L	1.55	1.70	1.85
L ₁	0.55	0.7	0.85
L ₂	0.45	0.6	0.75
M	0.08 REF.		
β	8°	10°	12°
K	4.25	4.40	4.55